

# PS9324L, PS9324L2

R08DS0060EJ0100 Rev.1.00

Apr 26, 2013

HIGH CMR, 10 Mbps OPEN COLLECTOR OUTPUT TYPE, 6-PIN SDIP PHOTOCOUPLER

# DESCRIPTION

The PS9324L and PS9324L2 are optical coupled high-speed, active low type isolators containing a GaAlAs LED on the input side and a photodiode and a signal processing circuit on the output side on one chip.

The PS9324L is lead bending type (Gull-wing) for surface mounting.

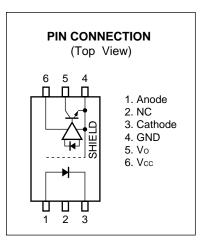
The PS9324L2 is lead bending type for long creepage distance (Gull-wing) for surface mount.

# **FEATURES**

- High common mode transient immunity (CM<sub>H</sub>, CM<sub>L</sub> =  $\pm 15 \text{ kV}/\mu \text{s}$  MIN.)
- Half size of 8-pin DIP
- Long creepage distance (8 mm MIN.: PS9324L2)
- High-speed (10 Mbps)
- High-speed response ( $t_{PHL} = 75$  ns MAX.,  $t_{PLH} = 75$  ns MAX.)
- Low power consumption ( $V_{CC} = 3.3/5$  V)
- Open collector output
- High isolation voltage (BV = 5 000 Vr.m.s.)
- Embossed tape product : PS9324L-E3 : 2 000 pcs/reel
  - : PS9324L2-E3: 2 000 pcs/reel
- Pb-Free product
- Safety standards
  - UL approved: No. E72422
  - CSA approved: No. CA 101391 (CA5A, CAN/CSA-C22.2 60065, 60950)
  - SEMKO approved (EN 60065, EN 60950)
  - DIN EN 60747-5-5 (VDE 0884-5) approved (Option)

# APPLICATIONS

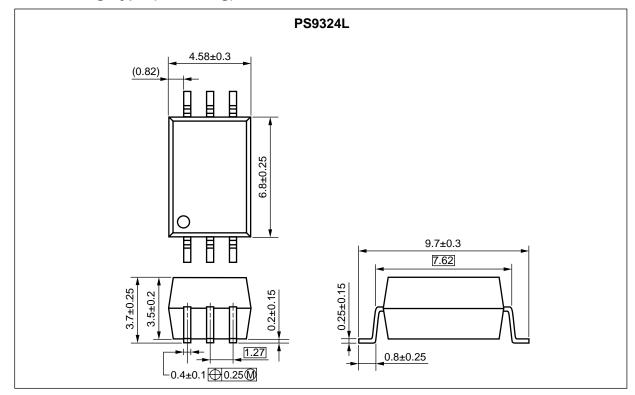
- Measurement equipment
- PDP
- FA Network



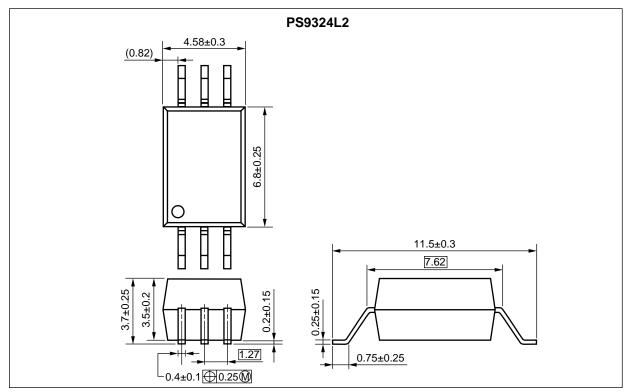


# PACKAGE DIMENSIONS (UNIT: mm)

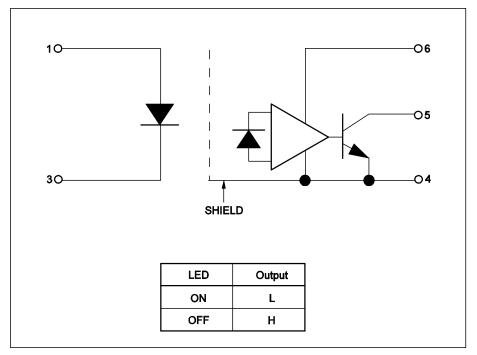
# Lead Bending Type (Gull-wing) For Surface Mount



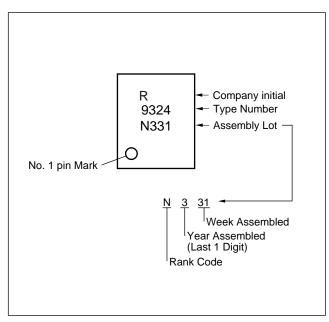
# Lead Bending Type (Gull-wing) For Long Creepage Distance (Surface Mount)



## **BLOCK DIAGRAM**



## MARKING EXAMPLE



# PHOTOCOUPLER CONSTRUCTION

Parameter	PS9324L	PS9324L2
Air Distance (MIN.)	7 mm	8 mm
Outer Creepage Distance (MIN.)	7 mm	8 mm
Isolation Distance (MIN.)	0.4 mm	0.4 mm



# **ORDERING INFORMATION**

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number <sup>*1</sup>
PS9324L	PS9324L-AX	Pb-Free	20 pcs (Tape 20 pcs cut)	Standard products	PS9324L
PS9324L-E3	PS9324L-E3-AX	(Ni/Pd/Au)	Embossed Tape 2 000 pcs/reel	UL, CSA ,SEMKO approval)	
PS9324L2	PS9324L2-AX		20 pcs (Tape 20 pcs cut)	Standard products	PS9324L2
PS9324L2-E3	PS9324L2-E3-AX	t l	Embossed Tape 2 000 pcs/reel	UL, CSA ,SEMKO approval)	
PS9324L-V	PS9324L-V-AX		20 pcs (Tape 20 pcs cut)	DIN EN 60747-5-5	PS9324L
PS9324L-V-E3	PS9324L-V-E3-AX	Ť	Embossed Tape 2 000 pcs/reel	(VDE 0884-5) Approved (Option)	
PS9324L2-V	PS9324L2-V-AX		20 pcs (Tape 20 pcs cut)	DIN EN 60747-5-5	PS9324L2
PS9324L2-V-E3	PS9324L2-V-E3-AX	•	Embossed Tape 2 000 pcs/reel	(VDE 0884-5) Approved (Option)	

Note: \*1. For the application of the Safety Standard, following part number should be used.



# ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^{\circ}C$ , unless otherwise specified)

	Parameter		Ratings	Unit
Diode	Forward Current *1	IF	25	mA
	Reverse Voltage	V <sub>R</sub>	5	V
Detector	Supply Voltage	V <sub>CC</sub>	7	V
	Output Voltage	Vo	7	V
	Output Current	Ι <sub>Ο</sub>	25	mA
	Power Dissipation *2	Pc	200	mW
Isolation \	/oltage * <sup>3</sup>	BV	5 000	Vr.m.s.
Operating Ambient Temperature		T <sub>A</sub>	-40 to +110	°C
Storage T	emperature	T <sub>stg</sub>	–55 to +125	°C

Notes: \*1. Reduced to 0.2 mA/°C at  $T_A$  = 25°C or more.

\*2. Reduced to 4.0 mW/°C at TA = 75°C or more.

\*3 AC voltage for 1 minute at  $T_A = 25^{\circ}$ C, RH = 60% between input and output. Pins 1-3 shorted together, 4-6 shorted together.

## **RECOMMENDED OPERATING CONDITIONS**

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Low Level Input Current	V <sub>FL</sub>	0		0.8	V
High Level Input Current	I <sub>FH</sub>	3.8	6	7.5	mA
Supply Voltage	Vcc	2.7		5.5	V
TTL ( $R_L = 1 \ k\Omega$ , loads)	N			5	
Pull-up Resistor	RL	330		4k	Ω

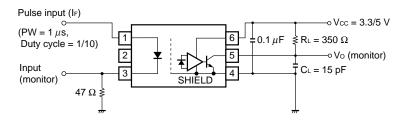


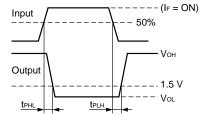
	Parameter	Symbol	Conditions	MIN.	TYP. <sup>*1</sup>	MAX.	Unit
Diode	ode Forward Voltage		I <sub>F</sub> = 10 mA, T <sub>A</sub> = 25°C	1.3	1.55	1.8	V
	Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 3 V, T <sub>A</sub> = 25°C			10	μA
	Terminal Capacitance	Ct	f = 1 MHz, V <sub>F</sub> = 0 V, T <sub>A</sub> = 25°C		30		pF
Detector High Level Output Current		Іон	$V_{CC} = V_0 = 3.3 \text{ V}, \text{ V}_F = 0.8 \text{ V}$		1	80	μA
		-011	$V_{CC} = V_O = 5.5 \text{ V}, \text{ V}_F = 0.8 \text{ V}$		1	100	,
	Low Level Output Voltage	V <sub>OL</sub>	$V_{CC} = 3.3 \text{ V}, \text{ I}_{\text{F}} = 4.5 \text{ mA},$		0.2	0.6	V
	Low Lover output rollage	• OL	$I_{OL} = 13 \text{ mA}$		0.2	0.0	•
			$V_{CC} = 5.5 \text{ V}, \text{ I}_{\text{F}} = 4.5 \text{ mA},$				
			$I_{OL} = 13 \text{ mA}$				
	High Level Supply Current	I <sub>ССН</sub>	$V_{\rm CC} = 3.3 \text{ V}, \text{ I}_{\rm F} = 0 \text{ mA},$		4	7	mA
		ICCH	$V_0 = open$			•	110 (
			$V_{\rm CC} = 5.5 \text{ V}, \text{ I}_{\rm F} = 0 \text{ mA},$				
			$V_0 = open$				
	Low Level Supply Current	ICCL	$V_{CC} = 3.3 \text{ V}, \text{ I}_{\text{F}} = 4.5 \text{ mA},$		6	10	mA
		ICCL	$V_0 = open$		0	10	шд
			$V_{\rm CC} = 5.5 \text{ V}, \text{ I}_{\rm F} = 4.5 \text{ mA},$		7	10	
			$V_0 = open$		'	10	
Coupled	Threshold Input Voltage	I <sub>FHL</sub>	$V_{CC} = 3.3 \text{ V}, \text{ R}_{\text{L}} = 350 \Omega,$		1	3	mA
coupleu	$(H \rightarrow L)$	IFHL	$V_{\rm O} = 0.8 \text{ V}$			5	
	$(\Pi \rightarrow L)$		$V_{\rm CC} = 5.0 \text{ V}, \text{ R}_{\rm L} = 350 \Omega,$				
			$V_{\rm CC} = 5.0$ V, RL = 550 $\Omega_2$ , V <sub>O</sub> = 0.8 V				
	Jaciation Desistance	Р		10 <sup>11</sup>			0
	Isolation Resistance	R <sub>I-O</sub>	$V_{I-O} = 1 \text{ kV}_{DC}, \text{ RH} = 40 \text{ to } 60\%$	10	0.0		Ω
	Isolation Capacitance	C <sub>I-O</sub>	$V_{I-O} = 0 V, f = 1 MHz,$		0.6		pF
	Dreperation Dalay Time	4	$T_A = 25^{\circ}C$		40	75	
	Propagation Delay Time	t <sub>PHL</sub>	$T_{A} = 25^{\circ}C$		40	75	ns
	$(H \rightarrow L)^{*2}$		$V_{CC} = 3.3 \text{ V}, \text{ I}_{\text{F}} = 4.5 \text{ mA},$			100	
			$R_{L} = 350 \Omega, C_{L} = 15 pF$		40	75	
			$T_{A} = 25^{\circ}C$		40	75	
			$V_{CC} = 5 V, I_F = 4.5 mA,$			100	
			$R_L = 350 \Omega, C_L = 15 pF$				
	Propagation Delay Time	t <sub>PLH</sub>	T <sub>A</sub> = 25°C		50	75	ns
	$(L \rightarrow H)^{*2}$		$V_{CC}$ = 3.3 V, I <sub>F</sub> = 4.5 mA,			100	
			R <sub>L</sub> = 350 Ω, C <sub>L</sub> = 15 pF				
			T <sub>A</sub> = 25°C		45	75	
			$V_{CC}$ = 5 V, I <sub>F</sub> = 4.5 mA,			100	
			R <sub>L</sub> = 350 Ω, C <sub>L</sub> = 15 pF				
	Pulse Width Distortion	t <sub>PHL-</sub> t <sub>PLH</sub>	$V_{CC}$ = 3.3/5 V, I <sub>F</sub> = 4.5 mA,		5	35	ns
	(PWD) <sup>*2</sup>		$R_L$ = 350 Ω, $C_L$ = 15 pF				
	Propagation Delay Skew <sup>*2</sup>	t <sub>psk</sub>	$V_{CC}$ = 3.3/5 V, $I_F$ = 4.5 mA,			40	ns
			$R_L$ = 350 Ω, $C_L$ = 15 pF				
	Rise Time <sup>*3</sup>	tr	V <sub>CC</sub> = 3.3/5 V, I <sub>F</sub> = 4.5 mA,		20		ns
			$R_L$ = 350 Ω, $C_L$ = 15 pF				
	Fall Time <sup>*3</sup>	t <sub>f</sub>	$V_{CC} = 3.3/5 \text{ V}, I_F = 4.5 \text{ mA},$		5		ns
			R <sub>L</sub> = 350 Ω, C <sub>L</sub> = 15 pF				
	Common Mode	CM <sub>H</sub>	$V_{CC} = 3.3/5 \text{ V}, I_F = 0 \text{ mA},$	15	20		kV/μ
	Transient Immunity at		$V_0 > 2 V, R_L = 350 \Omega,$	-	-		.,~
	High Level Output*4		$V_{CM} = 1.5 \text{ kV}, T_A = 25^{\circ}\text{C}$				
	Common Mode	CML	$V_{CC} = 3.3/5 \text{ V}, I_F = 4.5 \text{ mA},$	15	20		kV/μ
	Transient Immunity at Low		$V_{\rm O} < 0.8 \text{ V}, \text{ R}$ = 350 $\Omega$ ,	.0	20		πνημ
	Level Output <sup>*4</sup>	1	$10^{-1}$ $0.0^{-1}$ , $11^{-1}$ $000^{-1}$				1

# ELECTRICAL CHARACTERISTICS ( $T_A = -40$ to +110°C, unless otherwise specified)

#### Notes: \*1. Typical values at T<sub>A</sub> = 25°C

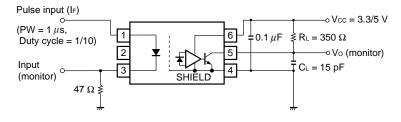
\*2. Test circuit for propagation delay time

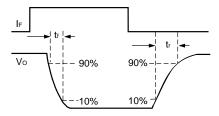




Remark CL includes probe and stray wiring capacitance.

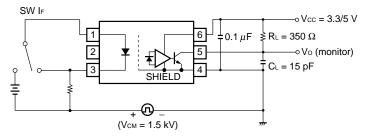
\*3. Test circuit for switching time

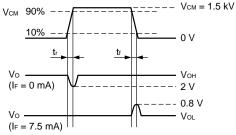




**Remark** C<sub>L</sub> includes probe and stray wiring capacitance.

\*4. Test circuit for common mode transient immunity

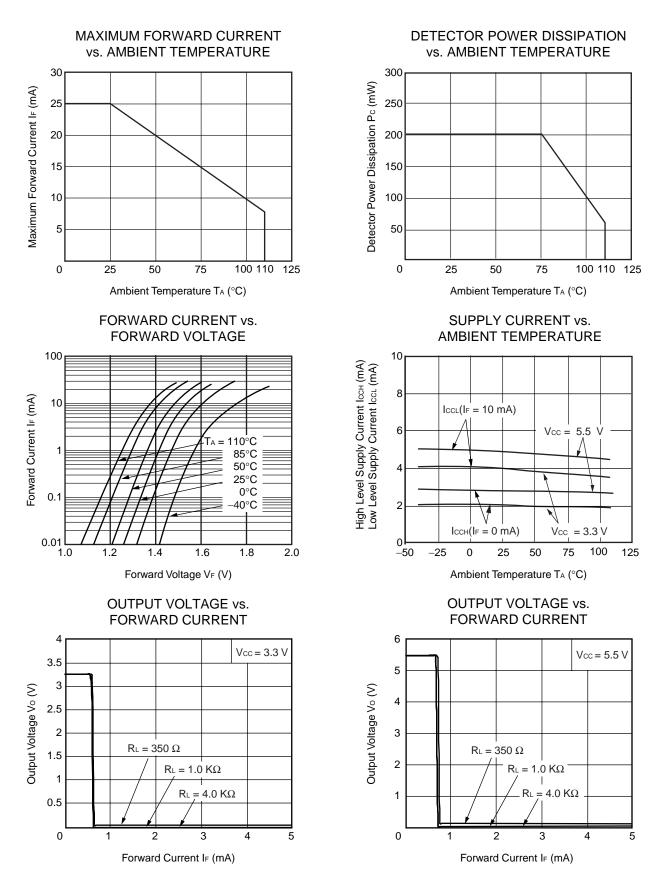




Remark C<sub>L</sub> includes probe and stray wiring capacitance.

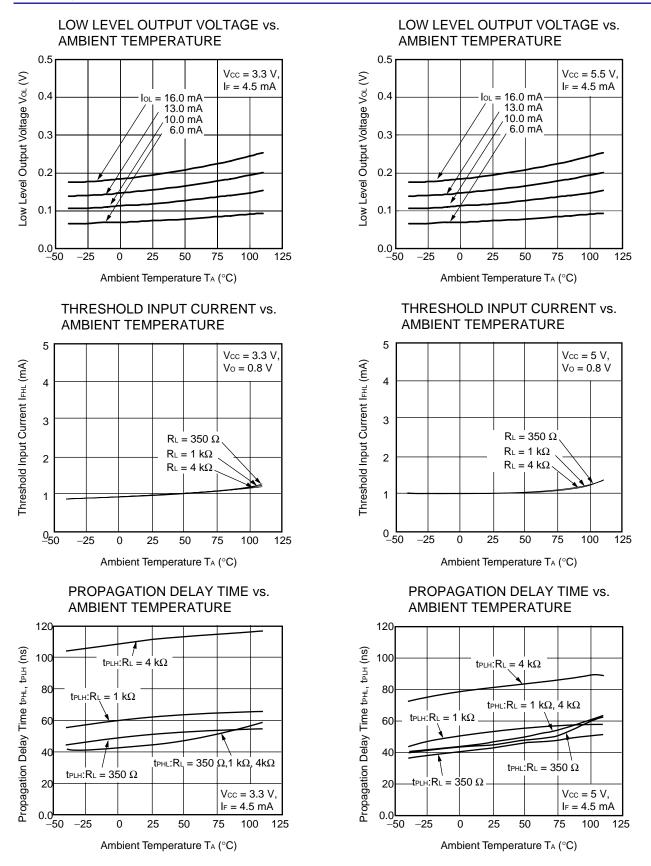


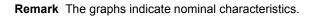
# TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)



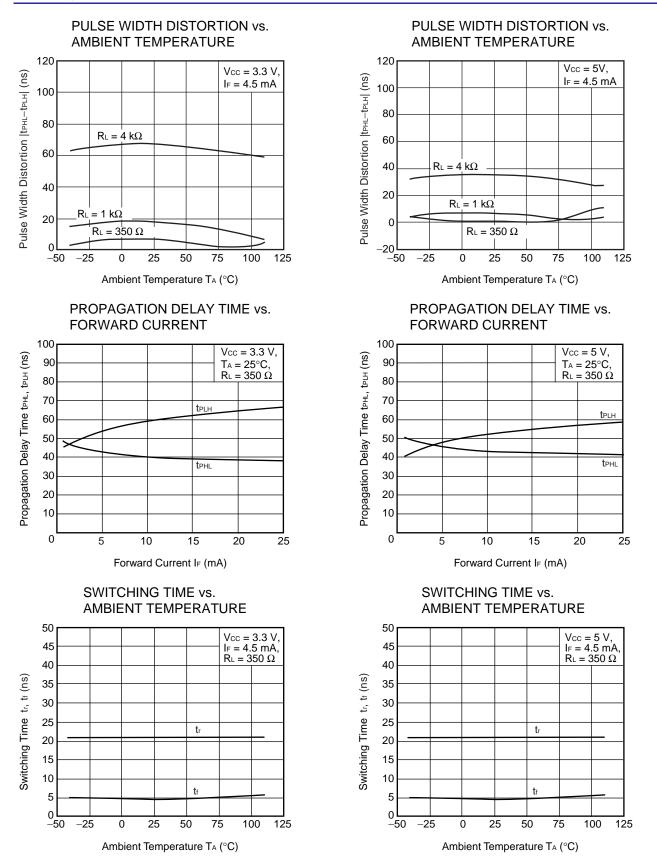
Remark The graphs indicate nominal characteristics.





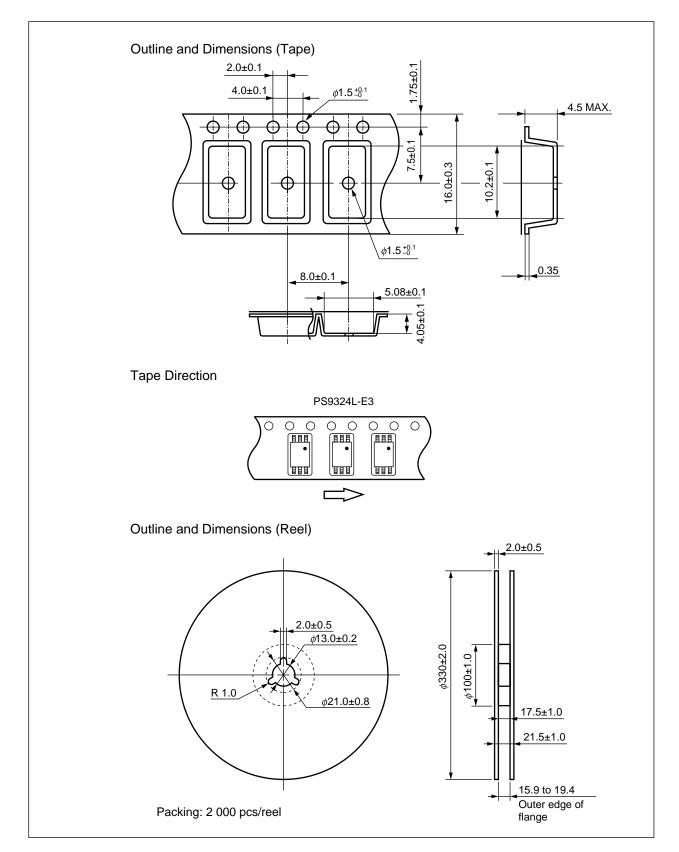


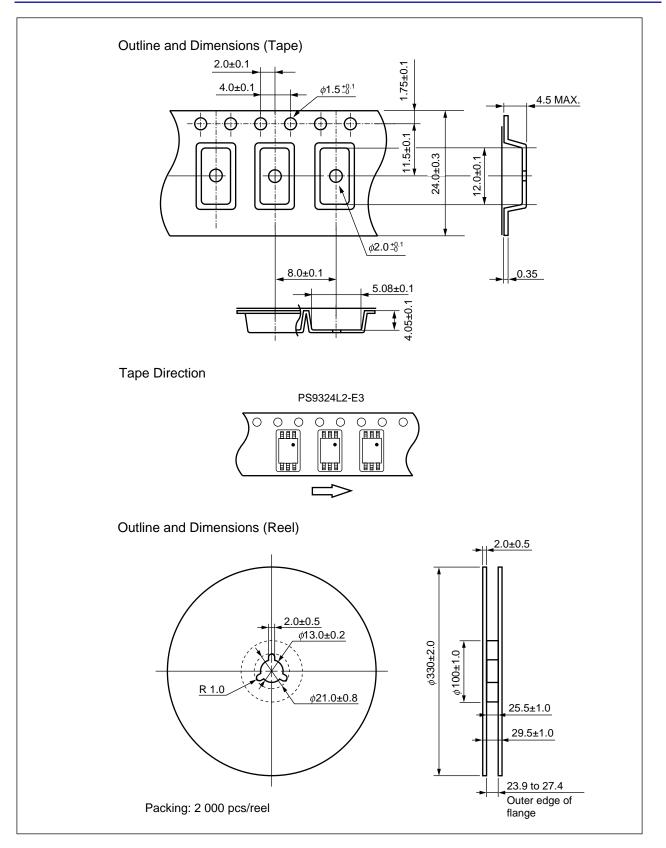




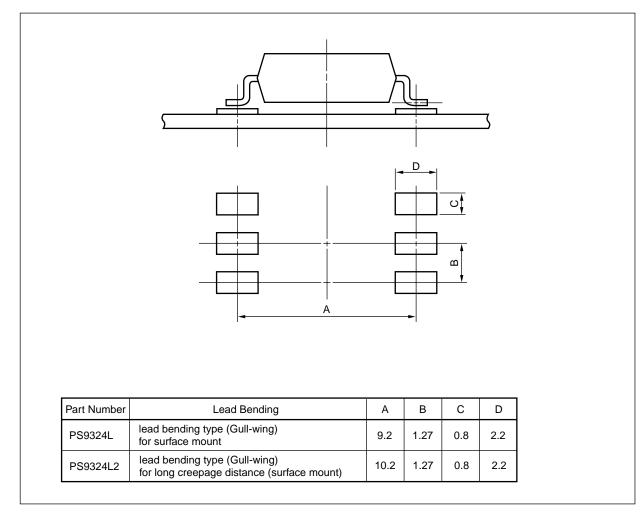
Remark The graphs indicate nominal characteristics.

# TAPING SPECIFICATIONS (UNIT: mm)





#### **RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)**





#### NOTES ON HANDLING

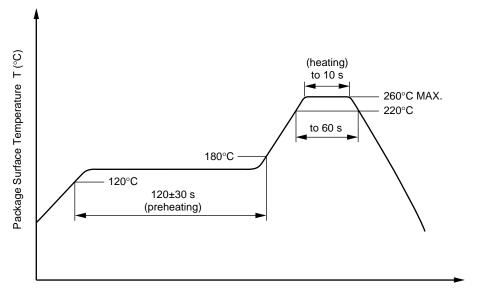
#### 1. Recommended soldering conditions

- (1) Infrared reflow soldering
  - · Peak reflow temperature 260°C or below (package surface temperature)
  - Time of peak reflow temperature
  - Time of temperature higher than 220°C
  - Time to preheat temperature from 120 to 180°C
  - Number of reflows

- 10 seconds or less
- 60 seconds or less
- 120±30 s
- Flux

Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

#### Recommended Temperature Profile of Infrared Reflow





#### (2) Wave soldering

• Time

• Flux

#### • Temperature

- 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)

260°C or below (molten solder temperature)

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

#### (3) Soldering by soldering iron

Peak temperature (lead part temperature)	350°C or below
Time (each pin)	3 seconds or less
• Flux	Rosin flux containing small amount of chlorine (The flux with a
	maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

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#### (4) Cautions

#### Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

#### 2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collectoremitters at startup, the output side may enter the on state, even if the voltage is within the absolute maximum ratings.

# **USAGE CAUTIONS**

- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of more than  $0.1 \,\mu\text{F}$  is used between V<sub>CC</sub> and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- 3. When  $V_{DD}$  is lower than around 2 V, the output( $V_0$ ) of this product is unstable, and this might produce undesirable operation. Be sure to check the operation of an IC or a discrete component that is connected to this product during Power-up and Power-down process. And we recommend to use a disable function (shutdown function ) of the connected IC or a reset IC to avoid this undesirable operation.
- 4. Pin 2 (which is an NC<sup>\*1</sup> pin) can either be connected directly to the GND pin on the LED side or left open. Unconnected pins should not be used as a bypass for signals or for any other similar purpose because this may degrade the internal noise environment of the device. Note: \*1. NC: Non-Connection (No Connection).
- 5. Avoid storage at a high temperature and high humidity.



SPECIFICATION OF	VDE	MARKS	LICENSE	DOCUMENT
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Parameter	Symbol	Spec.	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		40/110/21	
Dielectric strength maximum operating isolation voltage Test voltage (partial discharge test, procedure a for type test and random test) $U_{pr} = 1.6 \times U_{IORM}, P_d < 5 pC$	Uiorm Upr	1 130 1 808	V <sub>peak</sub> V <sub>peak</sub>
Test voltage (partial discharge test, procedure b for all devices) $U_{pr}$ = 1.875 $\times$ U_{IORM}, P_d < 5 pC	Upr	2 119	V <sub>peak</sub>
Highest permissible overvoltage	Utr	8 000	Vpeak
Degree of pollution (DIN EN 60664-1 VDE0110 Part 1)		2	
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303 Part 11))	CTI	175	
Material group (DIN EN 60664-1 VDE0110 Part 1)		lli a	
Storage temperature range	Tstg	-55 to +125	°C
Operating temperature range	TA	-40 to +110	°C
Isolation resistance, minimum value $V_{IO} = 500 \text{ V dc at } T_A = 25^{\circ}\text{C}$ $V_{IO} = 500 \text{ V dc at } T_A MAX. at least 100^{\circ}\text{C}$	Ris MIN. Ris MIN.	10 <sup>12</sup> 10 <sup>11</sup>	Ω Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) Package temperature Current (input current IF, Psi = 0) Power (output or total power dissipation) Isolation resistance	Tsi Isi Psi	175 400 700	°C mA mW
V <sub>IO</sub> = 500 V dc at T <sub>A</sub> = Tsi	Ris MIN.	10 <sup>9</sup>	Ω



Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	<ul> <li>Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.</li> </ul>
	<ol> <li>Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.</li> </ol>
	<ol><li>Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.</li></ol>
	Do not burn, destroy, cut, crush, or chemically dissolve the product.
	Do not lick the product or in any way allow it to enter the mouth.



**Revision History** 

# PS9324L, PS9324L2 Data Sheet

			Description		
Rev.	Date	Page	Summary		
1.00	Apr 26, 2013	-	First Edition Issued		

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